

OT2-SN62-T4

Rev: 15.2

Date 2021.06.28
 Language English
 SDS 950707



SUMMARY

SnPb - Premium latest technology No-Clean, Fine Pitch solder paste - Halide/Halogen free

PASTE	OT2-SN62-T4	
PROCESS		
No-Clean process		9
Post-solder cleaning		9

INDUSTRY APPLICATION		
Standard electronics		9
Industrial electronics		9
Hi-Rel electronics (automotive)		9

PROCESS CAPABILITY		
Squeegee		9
ProFlow		TBD
Pb-free Profile Air, short		9
Pb-free Profile Air, long		9
Pb-free process N2		9
Vapor phase process		7
Shiny joint appearance		9
Cosmetic cleanliness		9
ICCT compatible		9
Conformal coating		8

Legend		
<i>Especially made for this purpose</i>		9 - 10
<i>Generally qualified for this purpose</i>		7 - 8
<i>Generally usable, but not the best choice</i>		5 - 6
<i>Generally not usable for this purpose</i>		3 - 4
<i>Wrong choice</i>		1 - 2

Check material compatibility with every process change!

Industrial chemical product.

Read MSDS before use.

Product contains SVHC substance Lead with more than 0,1 Mass%.

Disclaimer:

This information is intended as advice to the best of our knowledge. The provided data is based on our own measurements, they do not provide any guaranteed properties nor are these delivery specifications. Due to the versatility of materials, applications and taking in consideration the industrial property rights of third parties, Balver Zinn Josef Jost GmbH & Co. KG cannot take any liability.

CLASSIFICATION		
DIN-EN-29454-1: 1994		1.1.3.C
IPC-J-STD-004-A: 2004		ROLO
IPC-J-STD-005: 1995 (Powder)		T4
Particle size	[µm]	20-38

PROPERTIES		
Flux code		OT2
Alloy Code		SN62
Alloy composition		Sn62Pb36Ag2
Liquidus	[°C]	179
Solidus	[°C]	179
Recommended peak temp.	[°C]	205-225
Acid number	[mg KOH/g]	142.9
Flux	[% w/w]	11
Residues		Colorless
Tackiness Malcom TK1	JIS-Z-3284	[gf] @ 0h
		90

TEST REPORTS			
IPC/ANSI-J-STD-005			Compliant
Certificate of Compliance			Website
Declaration of Conformity 2011/65/EU (RoHS)			No
Application Note			EN/DE
Copper Mirror	IPC-TM-650 2.3.32		Pass
Halides	IPC-TM-650 2.3.33	[Silver Chromate]	Pass
Halide	IPC-TM-650 2.3.35.1	[Fluoride by Spot]	Pass
Copper Corrosion	IPC-TM-650 2.6.15		Pass
SIR	IPC-TM-650 2.6.3.3		Pass
ECM	IPC-TM-650 2.6.14.1		Pass

PACKAGING AND STORAGE		
Packaging jar	PP [g]	500
Packaging cartridge	HDPE [g]	650
Packaging cartridge	HDPE [g]	1300
Packaging Cassette Pro-Flow	[g]	800
Minimum shelf-life in months	4-10 °C	5